Honeywell's Docket No. 30-4907 DIV (4780)
Practitioner's Docket No. 51-008-014

GROUP 17003 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Non-Fee Amendment Assistant Commissioner for Patents Washington, D.C. 20231

POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST (REVOCATION OF PRIOR POWERS)

As assignee of record of the entire interest of the above identified application,

REVOCATION OF PRIOR POWERS OF ATTORNEY

all powers of attorney previously given are hereby revoked and

NEW POWER OF ATTORNEY

the following practitioner is hereby appointed to prosecute and transact all business in the Patent and Trademark Office connected therewith.

Sandra P. Thompson, Registration No. 46264 Roger H. Criss, Registration No. 25570 Melanie Brown, Registration No. 31592 Curtis Brueske, Registration No. 33839 Shannon Morris, Registration No. 42909 Shannon Votava, Registration No. 48272



SEND CORRESPONDENCE TO:

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Sandra P. Thompson Riordan & McKinzie 600 Anton Blvd., 18th Floor Costa Mesa, CA 92626

Sandra Poteat Thompson (714) 433-2622

Application No.	Filing Date	Title	Reel/Frame No.	Status
09/741634	12/19/2000	ELK Dielectric Materials With Layered Structure	011404/0606	Pending
09/860993	05/17/2001	Hardmask for Electronic Applications	011838/0670	Pending
09/545058	04/07/2000	Low Dielectric Constant Organic Dielectrics Based on Cage-Like Structures	010725/0813	Issued
09/902924	07/10/2001	Low Dielectric Constant Organic Dielectrics Based on Cage-Like Structures	010725/0813	Pending
10/293024	11/12/2002	Low Dielectric Constant Organic Dielectrics Based on Cage-Like Structures	010725/0813	Pending
09/618945	07/19/2000	Compositions and Methods for Thermosetting Molecules in Organic Compositions	011294/0174	Issued
10/176335	06/19/2002	Compositions and Methods for Thermosetting Molecules in Organic Compositions	011294/0174	Pending
10/267380	10/08/2002	Compositions and Methods for Thermosetting Molecules in Organic Compositions	011294/0174	Pending
09/587851	06/06/2000	Low Dielectric Constant Nano Composites	011075/0072	Issued
10/189318	07/03/2002	Low Dielectric Constant Nano Composites	011075/0072	Pending
Not Assigned Yet	03/13/2003	Low Dielectric Constant Nano Composites	011075/0072	Pending
09/792606	02/22/2001	Porous Low Dielectric Constant Film Made Using Hollow Polymer Particles	011570/0776	Allowed

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				Pending 7 200
				1901 701
10/339958	01/09/2003	Porous Low Dielectric Constant Film Made Using Hollow Polymer Particles	011570/0776	Pending 700
09/671022	09/26/2000	Reducing the Dielectric Constant of Flare Via Photogenerated Porosity	011184/0078	Issued
09/619237	07/19/2000	Low Dielectric Constant Materials With Polymeric Networks	011235/0828	Issued
10/004584	12/03/2001	Low Dielectric Constant Materials With Polymeric Networks	011235/0828	Pending
09/761529	01/11/2001	Colloidal Silica Composite Films for Premetal Dielectric Applications	011876/0745	Issued
10/188433	07/03/2002	Colloidal Silica Composite Films for Premetal Dielectric Applications	011876/0745	Pending
09/825380	04/02/2001	Smart Container for Bulk Delivery	011680/0042	Pending
10/263,204	10/01/2002	Enhancement of Thermomechanical Properties	Assignment not filed yet	Pending
09/943237	08/29/2001	CVD and Spin-On Process for Shallow Trench Isolation	012146/0238	Pending
09/768439	01/23/2001	Viscous Protective Overlayers For Planarization	011904/0977	Pending
09/205006	12/02/1998	Novolac Polymer Planarization Films With High Temperature Stability	9621/0857	Issued
09/735838	12/12/2000	Novolac Polymer Planarization Films With High Temperature Stability	9621/0857	Issued
09/735746	12/12/2000	Novolac Polymer Planarization Films With High Temperature Stability	9621/0857	Allowed
10/299127	12/18/2002	Novolac Polymer Planarization Films With High Temperature Stability	9621/0857	Pending
09/227035	01/07/1999	Dielectric Films From Organohydridosiloxane Resins With Low Organic Content	9698/0261	Issued
09/609437	06/30/2000	Dielectric Films From Organohydridosiloxane Resins With Low Organic Content	9698/0261	Issued
09/227498	01/07/1999	Dielectric Films From Organohydridosiloxane Resins With High Organic Content	9699/0648	Issued
09/609499	06/30/2000	Dielectric Films From Organohydridosiloxane Resins With High Organic Content	9699/0648	Issued

08/665189	06/14/1996	Process for Making Hydroxy-	Assignment	Issued
00/00310/		Substituted Ethynylated Bipehnyl	information not	
		Compounds	in file	
09/561387	04/27/2000	Reactive Aqueous Metal Oxide Sols	010778/0978	Issued
• • • • • • • • • • • • • • • • • • • •		As Polishing Slurries for Low		
		Dielectric Constant Materials		
10/214677	08/07/2002	Reactive Aqueous Metal Oxide Sols	010778/0978	Pending
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		Dielectric Constant Materials		
09/235141	01/21/1999	Solvent Systems For Low Dielectric	9907/0307	Issued
•		Constant Polymeric Materials		
09/340976	06/28/1999	Solvent Systems For Low Dielectric	9907/0307	Issued
		Constant Polymeric Materials		
10/143039	05/07/2002	Solvent Systems For Low Dielectric	9907/0307	Issued
		Constant Polymeric Materials		
10/299320	11/18/2002	Solvent Systems For Low Dielectric	9907/0307	Pending
		Constant Polymeric Materials		
09/160514	09/24/1998	Oxidizing Polishing Slurries For	9813/0001	Issued
		Low Dielectric Constant Materials		
09/882000	06/14/2001	Oxidizing Polishing Slurries For	9813/0001	Pending
		Low Dielectric Constant Materials		
08/665132	06/14/1996	Poly (Arylene Ether) Compositions	8190/0680	Issued
		and the Method for Their		3
		Manufacture		
09/659380	09/08/2000	Poly (Arylene Ether) Compositions	8190/0680	Issued
		and the Method for Their		
		Manufacture		
08/271291	07/06/1994	Novolac Polymer Planarization	01024/0036	Issued
		Films For Microelectronic		Į
		Structures		
09/055516	04/06/1998	Synthesis of	Assignment not	Issued
		Hydrogensilsesquioxane and	available at this	
		Organohydridosiloxane Resins	time	
09/698883	10/27/2000	Spin-On Glass Anti-Reflective	010245/0036	Issued
		Coating For Photolithography		
09/330248	11/13/2000	Spin-On Glass Anti-Reflective	010245/0036	Issued
		Coating For Photolithography		
10/012649	11/5/2001	Spin-On Glass Anti-Reflective	010245/0036	Pending
		Coating For Photolithography		
10/001143	11/15/2001	Spin-On Glass Anti-Reflective	010245/0036	Pending
		Coating For Photolithography		
09/491166	01/26/2000	Spin-On Glass Anti-Reflective	010245/0036	Issued
		Coating For Photolithography		
10/300357	11/19/2002	Spin-On Glass Anti-Reflective	010245/0036	Pending
•		Coating For Photolithography		J

10/076,846	02/14/2002	Spin-On Glass Anti-Reflective Coating For Photolithography	010245/0036	Pending
09/356487	07/19/1999	Compositions and Processes For Spin Etch Planarization	010117/0691	Pending
10/222230	08/15/2002	Compositions and Processes For Spin Etch Planarization	010117/0691	Pending
09/055244	04/06/1998	Synthesis of Siloxane Resins	Assignment not available at this time	Issued
09/505314	02/16/2000	Synthesis of Siloxane Resins	Assignment not available at this time	Pending
09/745266	12/20/2000	Composition for Chemical Mechanical Planarization of Copper, Tantalum, and Tantalum Nitride	010117/0800	Allowed
09/357264	07/19/1999	Composition for Chemical Mechanical Planarization of Copper, Tantalum, and Tantalum Nitride	010117/0800	Pending
08/489424	06/12/1996	Silicon Carboxide Composite Reinforced With Ceramic Fibers Having A Surface Enriched in Boron Nitride	Assignment not available at this time	Issued
09/590770	06/08/2000	Chemical Hydrodynamic Etch Planarization	011980/0176	Pending
09/547167	04/11/2000	Use of Sacrificial Inorganic Dielectrics for Dual Damascene Processes	012734/0060	Pending
09/390143	09/03/1999	Photoresist Ashing Process for Organic and Inorganic Polymer	Assignment not available at this time	Issued
09/417257	10/12/1999	Environment Controlled WIP Cart	Assignment not available at this time	Issued
09/422039	10/20/1999	Complex-Shaped Fiber for Particle and Molecular Filtration	010684/0327	Issued
09/833276	04/11/2001	Devices and Methods for Chemical Reactive Filtration	011792/0556	Pending
09/834581	04/12/2001	Devices and Methods for Chemical Reactive Filtration	012266/0121	Pending
09/617365	07/17/2000	Absorbing Compounds for Spin- On-Glass Anti-Reflective Coatings for Photolithography	Assignment not available at this time	Issued
10/012651	11/05/2001	Absorbing Compounds for Spin-	Assignment not	Allowed

		On-Glass Anti-Reflective Coatings	available at this	
		for Photolithography	time	
09/547187	04/11/2000	Chemical Mechanical Planarization of Low Dielectric Constant Materials	010757/0060	Issued
10/145649	05/14/2002	Chemical Mechanical Planarization of Low Dielectric Constant Materials	010757/0060	Pending
09/591181	06/08/2000	Edge Bead Removal for Spin-On Materials	011184/0225	Allowed
Serial No. Not Assigned	02/26/2003	Edge Bead Removal for Spin-On Materials.	011184/0225	Pending
09/420218	10/18/1999	Deposition of Organosilsesquioxane Films	Assignment not available at this time	Issued
10/150185	05/16/2002	Deposition of Organosilsesquioxane Films	Assignment not available at this time	Pending
09/420052	10/18/1999	Deposition of Fluorosilsesquioxane Films	Assignment not available at this time	Issued
10/150445	5/16/2002	Deposition of Fluorosilsesquioxane Films	Assignment not available at this time	Pending
09/197478	11/20/1998	Poly (Arylene Ether) Homopolymer Compositions and Methods of Manufacture Thereof	9747/0690	Issued
09/039289	3/12/1998	Stable Inorganic Polymers	9106/0106	<u>Issued</u>
09/044831	04/21/1997	Organohydridosiloxane Resins With Low Organic Content	Assignment not available at this time	Issued
09/610567	07/03/2000	Organohydridosiloxane Resins With Low Organic Content	Assignment not available at this time	Issued
09/044798	03/19/1998	Organohydridosiloxane Resins With High Organic Content	9067/0165	Issued
09/611528	06/30/2000	Organohydridosiloxane Resins With High Organic Content	9067/0165	Issued
10/299349	11/18/2002	Organohydridosiloxane Resins With High Organic Content	9067/0165	Pending
08/990157	12/12/1997	Poly (Arylene Ether) Compositions and Methods of Manufacture Thereof	9635/0730	Issued
09/847766	05/01/2001	Spin-On Planarizers and Metallic Solder Planarizers for SEP	Assignment not available at this time	Pending

09/327356	06/07/1999	Low Dielectric Constant Polyorganosilicon Coatings	011838/0670	Issued
		Generated From Polycarbosilanes		
09/746607	12/20/2000	Low Dielectric Constant Polyorganosilicon Contings	011838/0670	Issued
		Generated From Polycarbosilanes		
10/122400	04/11/2002	Low Dielectric Constant	011838/0670	Pending
		Polyorganosilicon Coatings		
		Generated From Polycarbosilanes	1	·
09/471299	12/23/1999	Hydridopolycarbosilane	010467/0172	Allowed
10/163144	06/04/2002	Hydridopolycarbosilane	010467/0172	Pending
09/420091	10/18/1999	Solvents for Processing	Assignment not	Issued
		Silsesquioxane and Siloxane Resins	available at this	
			time	
09/145921	09/03/1998	Method for Cleaning Organic	944/0152	Issued
		Dielectric Film Containing		
		Semiconductor Wafers]	
09/538276	03/30/2000	Nanoporous Polymers Having	010724/0678	Issued
	43/30/2400	Backbones With Reactive Groups	010,2 00.0	100.00
		Employed In Cross-Linking		
09/544722	04/06/2000	Nanoporous Polymers Crosslinked	Assignment not	Issued
07/044/22	04/00/2000	Via Cyclic Structures	available at this	13046
		Via Cyelle Da actores	time	1
09/544723	04/06/2000	Nanoporous Material Fabricated	Assignment not	Issued
	0 11 00.200	Using Polymeric Template Strands	available at this	
		graymone ramping	time	
09/544504	04/06/2000	Nanoporous Polymers Comprising	010723/0363	Issued
	1 55, 256	Macrocycles		
09/420611	10/18/1999	Nanoporous Material Fabricated	Assignment not	Issued
		Using A Dissolvable Phase	available at this	
	ł		time	1
09/420042	10/18/1999	Infiltrated Nanoporous Materials	Assignment not	Issued
		and Methods of Producing The	available at this	
		Same	time	
09/651396	08/29/2000	Infiltrated Nanoporous Materials	Assignment not	Pending
	13.27,2000	and Methods of Producing Same	available at this	
		Transact of a roughling built	time	
09/512971	02/24/2000	Alignment Plate with Matched	010640/0663	Allowed
	22.22000	Thermal Coefficient of Expansion	2100 10,000	
10/238800	09/09/2002	Alignment Plate with Matched	010640/0663	Pending
1 01 22 0000	V5. 05/2002	Thermal Coefficient of Expansion	010070/0003	Londing
		Thermal Coefficient of Expansion	L	L

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Date 4/14/03

Shannon Votava

Title: Assistant Secretary Honeywell International Inc.